

## High-Power Density 2W Laser Diode

### Description

The SLD324ZT is a gain-guided, high-power density laser diode with a built-in TE cooler. A new flat, square package with a low thermal resistance and an in-line pin configuration is employed. Fine tuning of the wavelength is possible by controlling the laser chip temperature.

### Features

- High power  
Recommended optical power output:  $P_o = 2.0W$
- Low operating current:  $I_{op} = 2.5A$  ( $P_o = 2.0W$ )
- Newly developed flat package with built-in photodiode, TE cooler and thermistor

### Applications

- Solid state laser excitation
- Medical use
- Material processes
- Measurement

### Structure

GaAlAs quantum well structure laser diode

### Operating Lifetime

MTTF 10,000H (effective value) at  $P_o = 2.0W$ ,  $T_{th} = 25^{\circ}C$

### Absolute Maximum Ratings ( $T_{th} = 25^{\circ}C$ )

• Optical power output	$P_o$	2.2
• Reverse voltage	$V_R$	LD 2
	PD	15
• Operating temperature ( $T_{th}$ )	$T_{opr}$	-10 to +30
• Storage temperature	$T_{stg}$	-40 to +85
• Operating current of TE cooler	$I_T$	4.0

### Pin Configuration (Top View)

No.	Function	No.	Function
1	TE Cooler (negative)	7	LD (cathode)
2	TE Cooler (negative)	8	LD (cathode)
3	Thermistor	9	PD (cathode)
4	Thermistor	10	PD (anode)
5	LD (anode)	11	TE Cooler (positive)
6	LD (anode)	12	TE Cooler (positive)

### Warranty

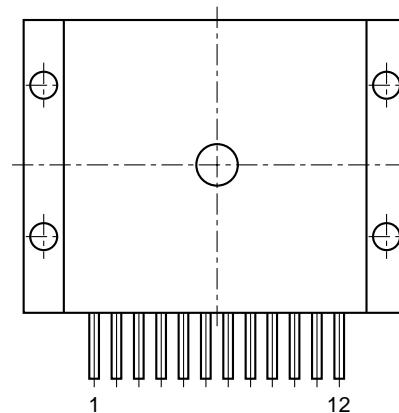
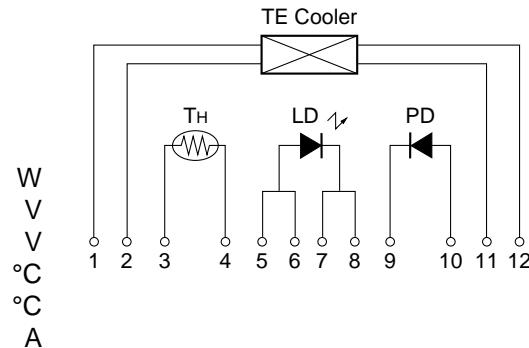
This warranty period shall be 90 days after receipt of the product or 1,000 hours operation time whichever is shorter.

Sony Quality Assurance Department shall analyze any product that fails during said warranty period, and if the analysis results show that the product failed due to material or manufacturing defects on the part of Sony, the product shall be replaced free of charge.

Laser diodes naturally have differing lifetimes which follow a Weibull distribution.

Special warranties are also available.

### Equivalent Circuit



Sony reserves the right to change products and specifications without prior notice. This information does not convey any license by any implication or otherwise under any patents or other right. Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits.

**Electrical and Optical Characteristics**(T<sub>th</sub>: Thermistor temperature, T<sub>th</sub> = 25°C)

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit	
Threshold current	I <sub>th</sub>			0.6	1.0	A	
Operating current	I <sub>op</sub>	P <sub>o</sub> = 2.0W		2.5	3.5	A	
Operating voltage	V <sub>op</sub>	P <sub>o</sub> = 2.0W		2.2	3.0	V	
Wavelength*1	λ <sub>p</sub>	P <sub>o</sub> = 2.0W	790		840	nm	
Monitor current	I <sub>mon</sub>	P <sub>o</sub> = 2.0W V <sub>R</sub> = 10V	0.15	0.8	3.0	mA	
Radiation angle (F. W. H. M.* )	Perpendicular	θ <sub>⊥</sub>	P <sub>o</sub> = 2.0W	20	30	40	degree
	Parallel	θ <sub>//</sub>		4	9	17	degree
Positional accuracy	Position	ΔX, ΔY	P <sub>o</sub> = 2.0W			±100	μm
	Angle	Δφ <sub>⊥</sub>				±3	degree
Differential efficiency	η <sub>D</sub>	P <sub>o</sub> = 2.0W	0.65	1.0		W/A	
Thermistor resistance	R <sub>th</sub>	T <sub>th</sub> = 25°C		10		kΩ	

\* F. W. H. M. : Full Width at Half Maximum

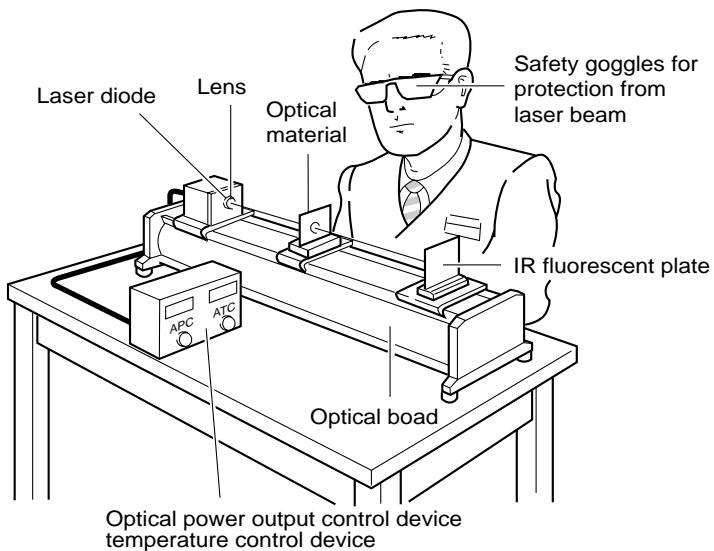
**\*1 Wavelength Selection Classification**

Type	Wavelength (nm)
SLD324ZT-1	795 ± 5
SLD324ZT-2	810 ± 10
SLD324ZT-3	830 ± 10

Type	Wavelength (nm)
SLD324ZT-21	798 ± 3
SLD324ZT-24	807 ± 3
SLD324ZT-25	810 ± 3

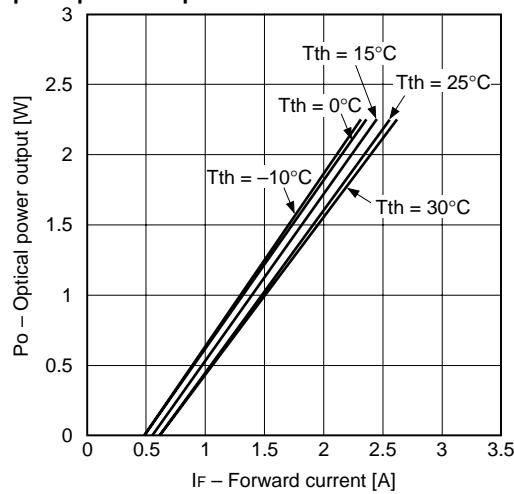
**Handling Precautions****Eye protection against laser beams**

The optical output of laser diodes ranges from several mW to 3W. However the optical power density of the laser beam at the diode chip reaches 1MW/cm<sup>2</sup>. Unlike gas lasers, since laser diode beams are divergent, uncollimated laser diode beams are fairly safe at a laser diode. For observing laser beams, ALWAYS use safety goggles that block infrared rays. Usage of IR scopes, IR cameras and fluorescent plates is also recommended for monitoring laser beams safely.

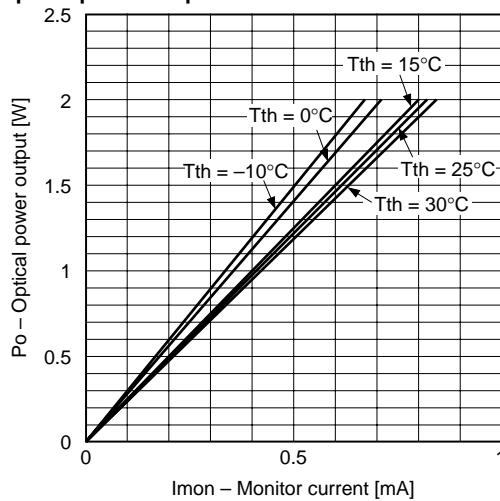


## Example of Representative Characteristics

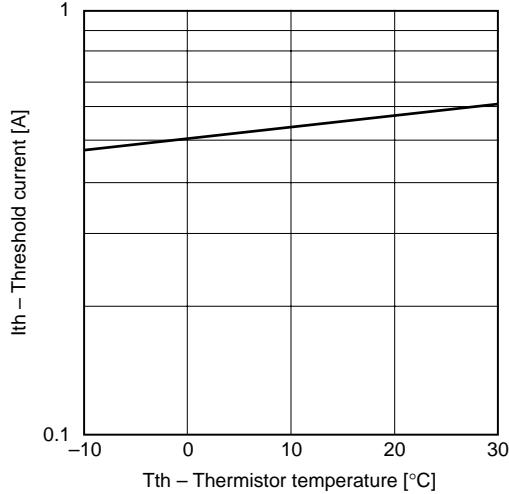
**Optical power output vs. Forward current characteristics**



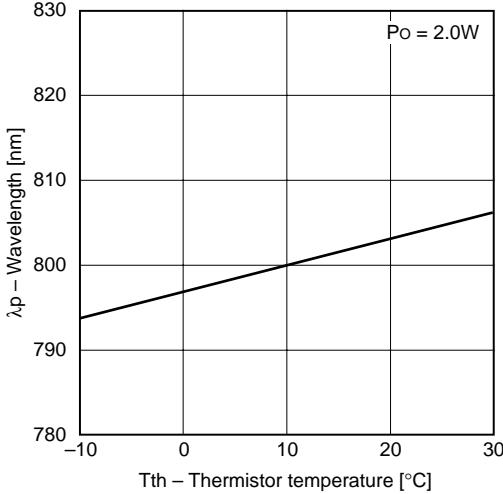
**Optical power output vs. Monitor current characteristics**



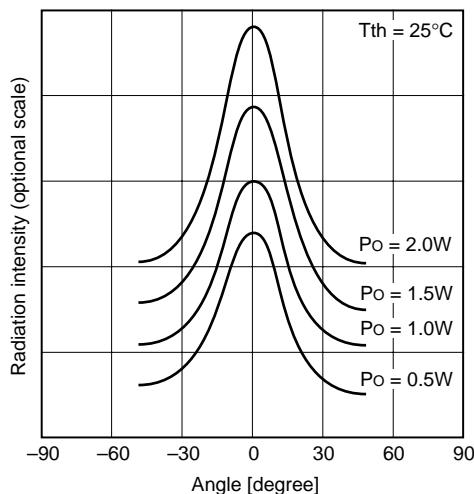
**Threshold current vs. Temperature characteristics**



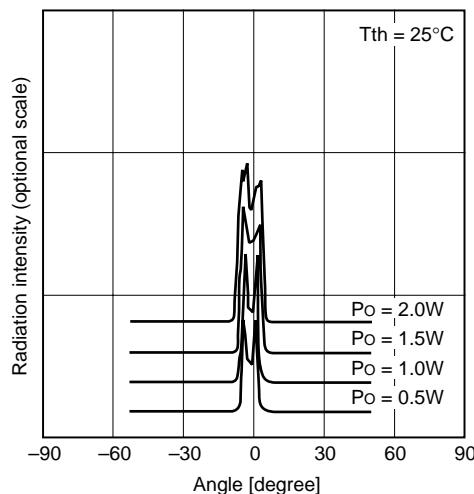
**Dependence of wavelength**

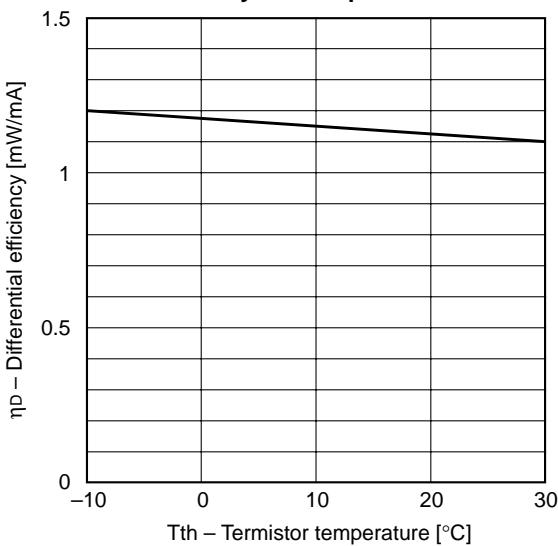
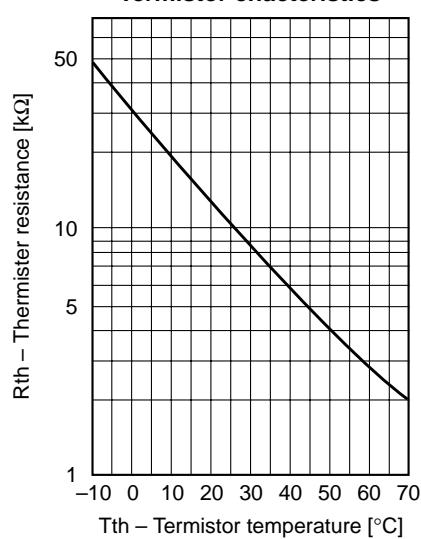
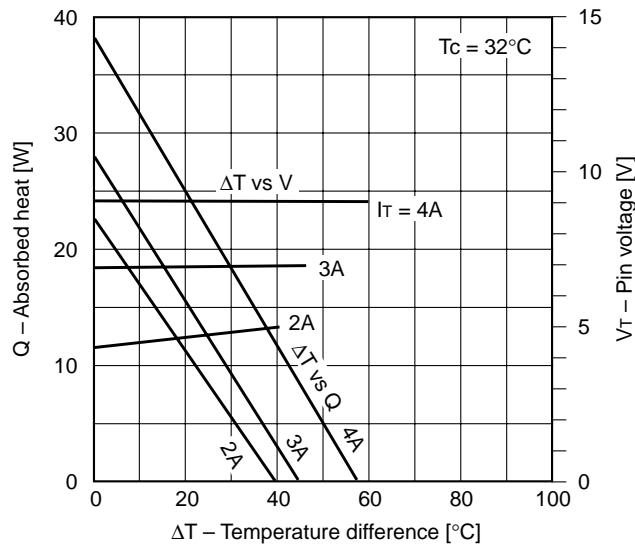
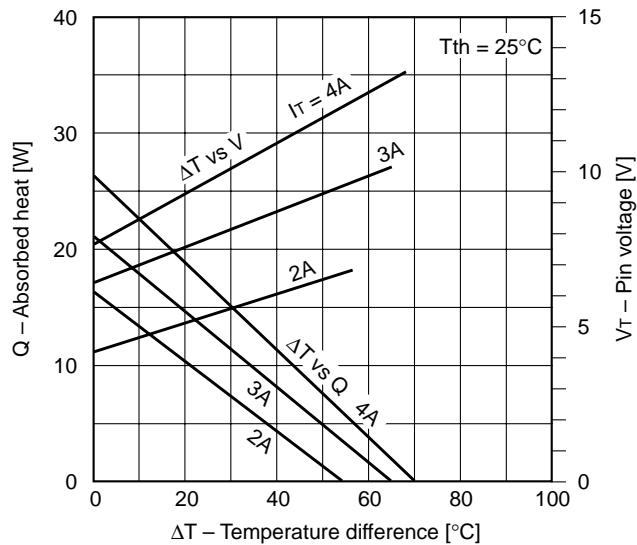


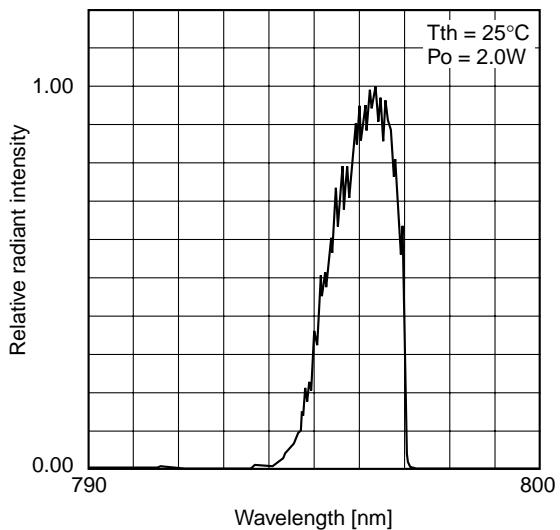
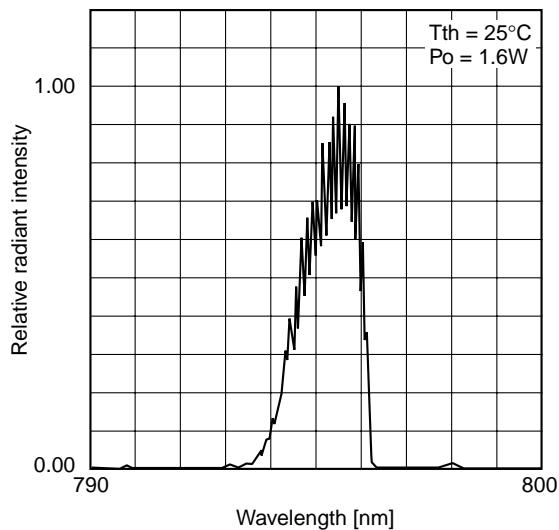
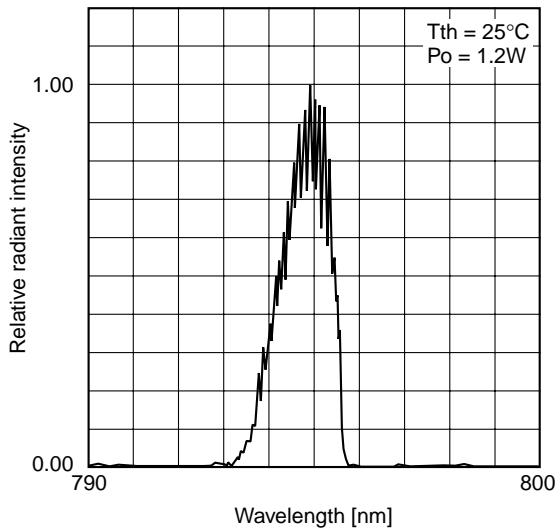
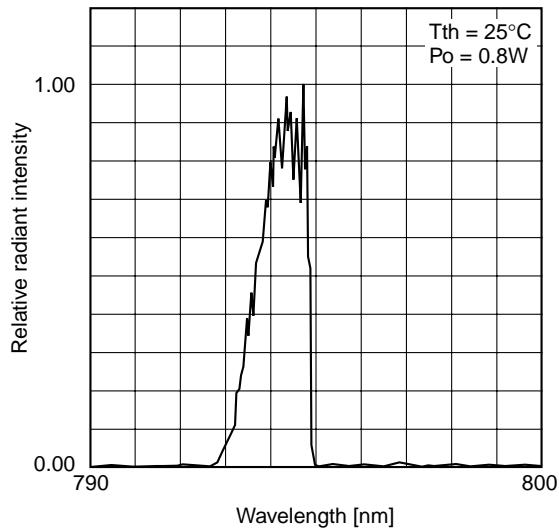
**Power dependence of far field pattern  
(Perpendicular to junction)**

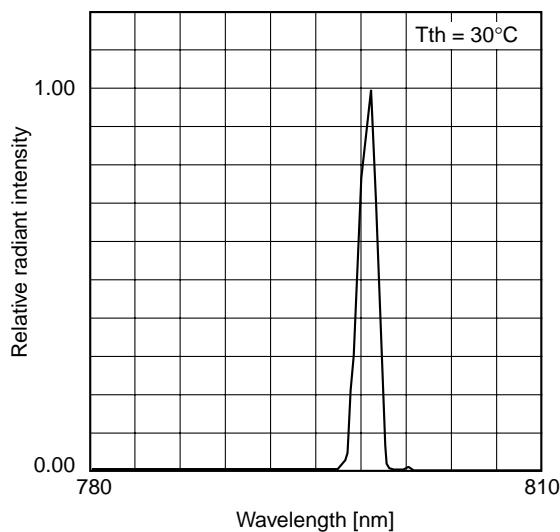
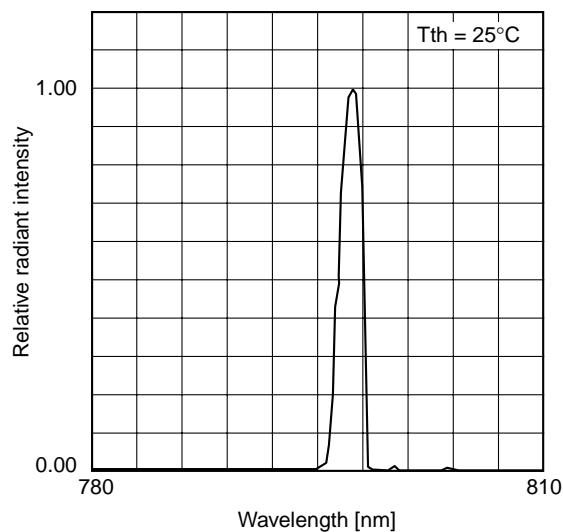
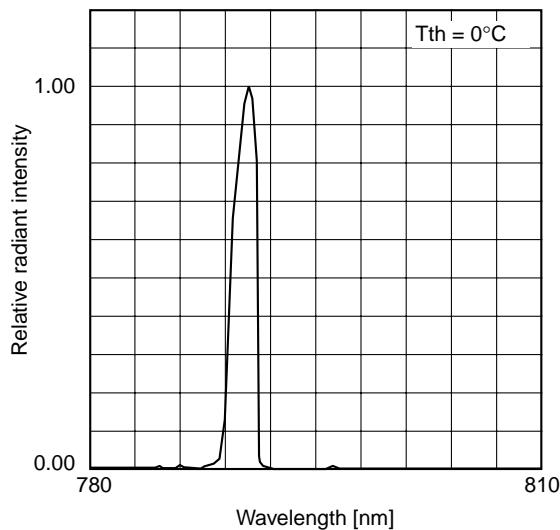
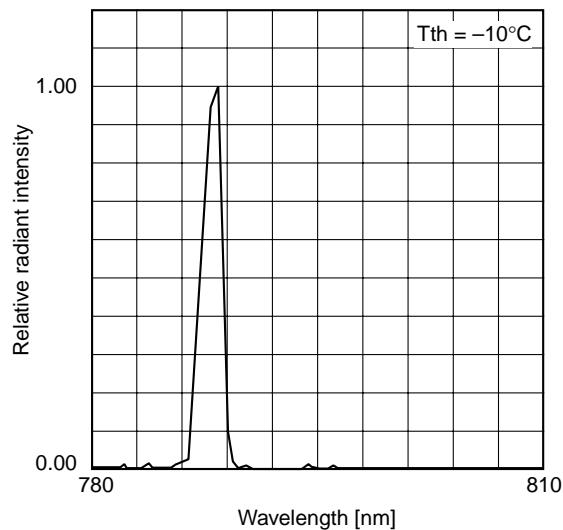


**Power dependence of far field pattern  
(Parallel to junction)**



**Differential efficiency vs. Temperature characteristics****Termistor characteristics****TE cooler characteristics****TE cooler characteristics 1****TE cooler characteristics 2** $\Delta T$ :  $T_c - T_{th}$ T<sub>th</sub>: Thermistor temperatureT<sub>c</sub>: Case temperature

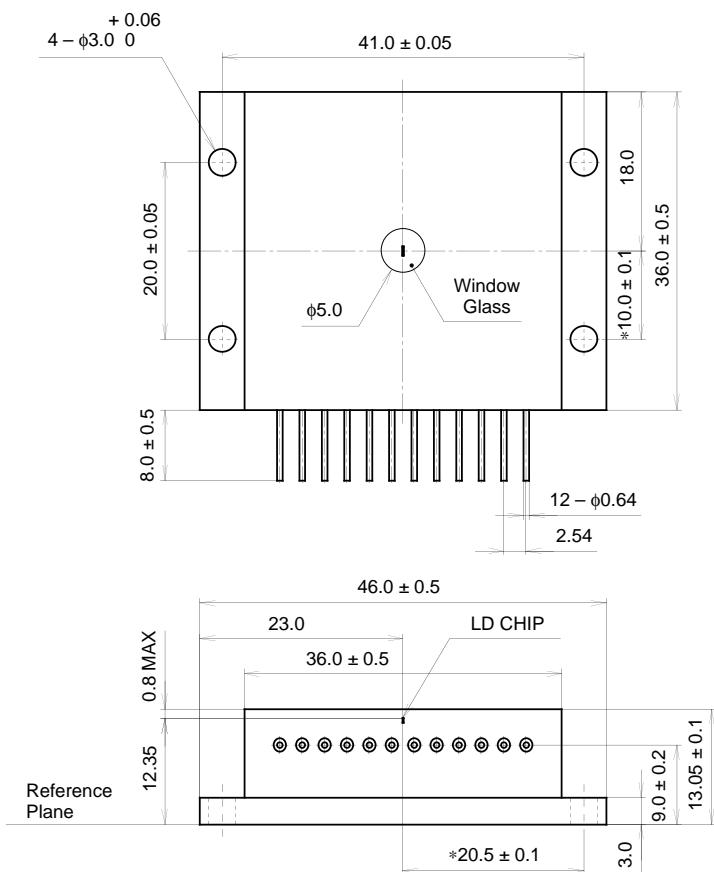
**Power dependence of spectrum**

**Temperature dependence of spectrum ( $P_o = 2W$ )**

## Package Outline

Unit: mm

M-272



SONY CODE	M-272
EIAJ CODE	_____
JEDEC CODE	_____

\*Distance between pilot hole and emitting area.

PACKAGE MASS	118 g
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